

Description

The AP1694 is a high performance AC/DC power factor corrector for mains dimmable LED driver applications. The device uses Pulse Frequency Modulation (PFM) technology to regulate output current while achieving high power factor and low THD. It operates as a BCM (Boundary Conduction Mode) controller which is good for EMI.

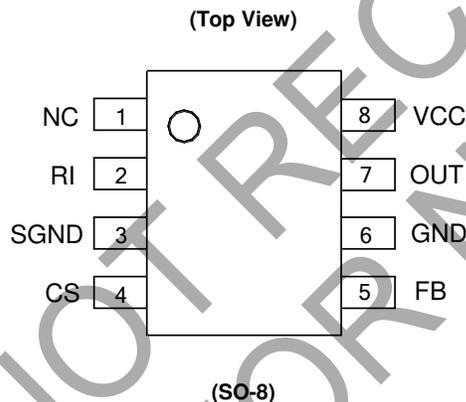
The AP1694 provides accurate constant current (CC) regulation while removing the opto-coupler and secondary control circuitry. It also eliminates the need of loop compensation circuitry while maintaining stability. It can meet the requirement of IEC6100-3-2 harmonic standard.

The AP1694 features low start-up current, low operation current. It adopts dynamic base driver control technology and valley on switching mode to achieve high efficiency. It also has rich protection features including over voltage, short circuit, over temperature protection.

The AP1694 provides the dimmable LED driver with a wide dimmer compatibility including leading edge and trailing edge dimmer. The AP1694 can achieve deep dimming down to 1%, while the dimming curve is compliant with the standard of NEMA SSL6.

The AP1694 is available in SO-8 package.

Pin Assignments



- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

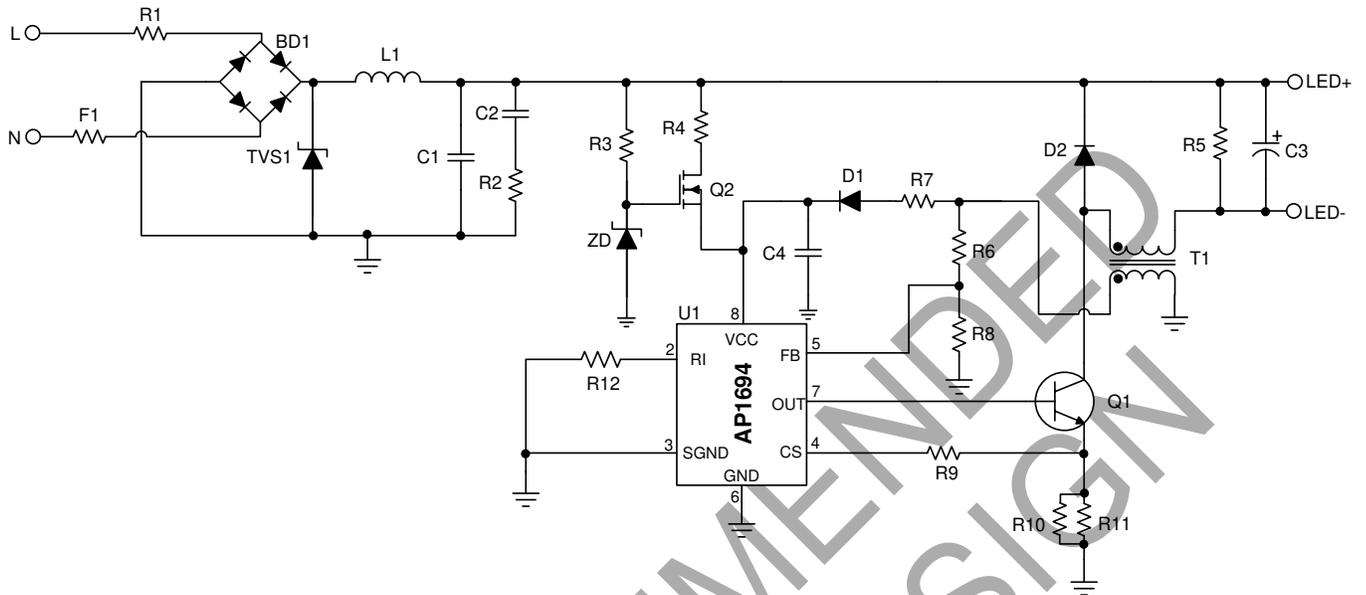
Features

- Primary Side Control for Output Current Regulation without Opto-coupler
- Boundary Conduction Mode (BCM) Operation to Achieve High-efficiency
- High PF and Low THD
- High Efficiency without Dimmer
- Wide Range of Dimmer Compatibility
- Dimming Curve Compliant with NEMA SSL6
- Low Start-up Current
- Tight LED Current
- Tight LED Open Voltage
- BJT Transistor Driver
- Dynamic Base Driver Control
- Valley-mode Switching to Minimize the Transition Loss
- Easy EMI
- Internal Protections:
 - Under Voltage Lock Out (UVLO)
 - Leading-edge Blanking (LEB)
 - Output Short Protection
 - Output Open Protection
 - Over Temperature Protection
- Flexible for Design with Small Form Factor and Very Low BOM Cost
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Applications

- Mains Dimmable LED Lighting

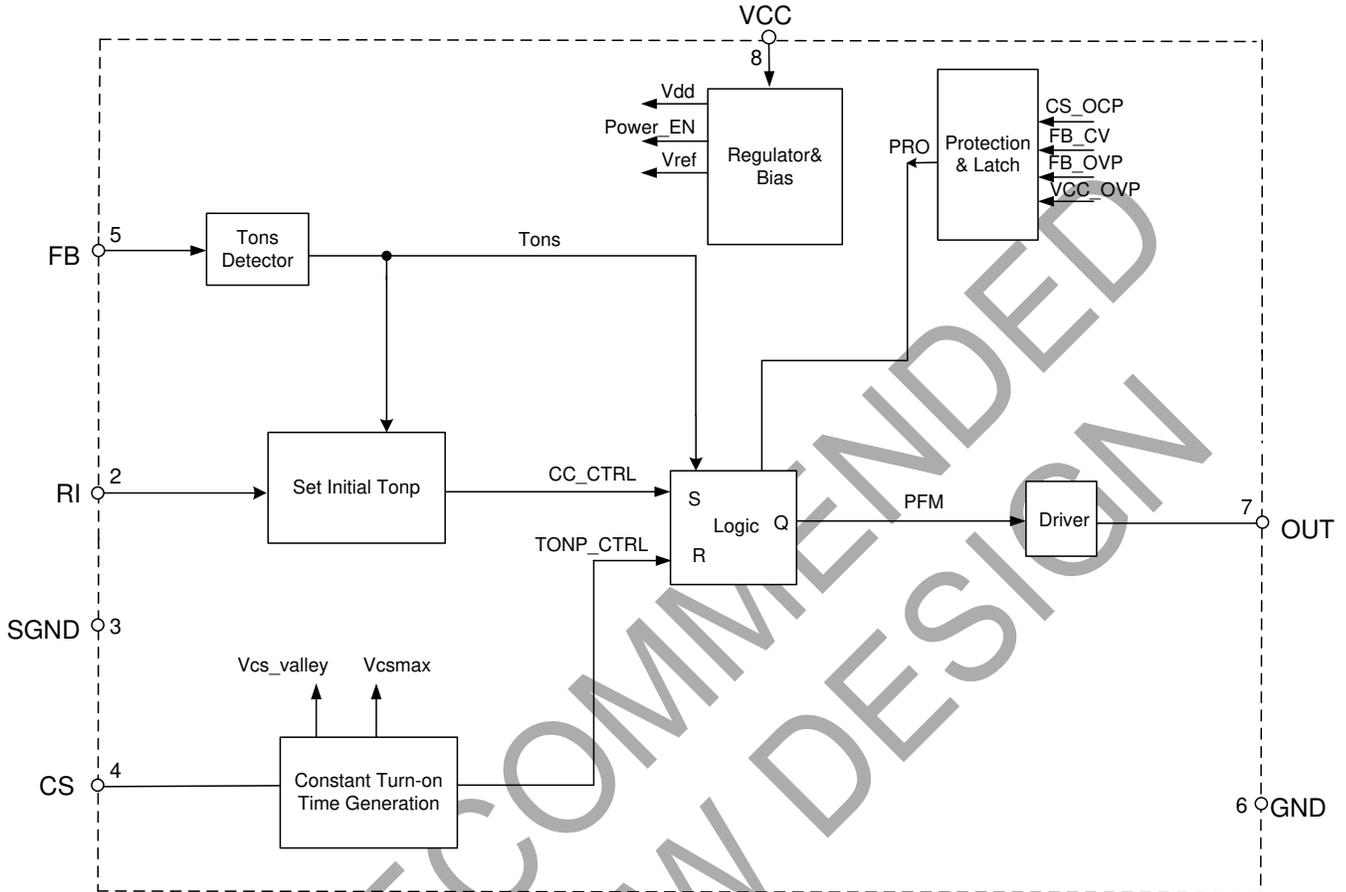
Typical Applications Circuit



Pin Descriptions

Pin Number	Pin Name	Function
1	NC	No connection.
2	RI	The initial on time setting resistor.
3	SGND	Must connect to GND.
4	CS	Primary current sensing.
5	FB	The feedback voltage from auxiliary winding
6	GND	Ground.
7	OUT	Gate driver output.
8	VCC	Supply voltage of gate driver and control circuits of the IC.

Functional Block Diagram



Absolute Maximum Ratings (Note 4) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V _{CC}	Power Supply Voltage	-0.3 to 35	V
I _{OUT}	Driver Output Current	150	mA
V _{CS}	Voltage at CS to GND	-0.3 to 7	V
V _{FB}	FB Input Voltage	-40 to 10	V
T _J	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C
T _{LEAD}	Lead Temperature (Soldering, 10 sec)	+300	°C
P _D	Power Dissipation (T _A = +50°C)	0.65	W
θ _{JA}	Thermal Resistance (Junction to Ambient)	160	°C/W
–	ESD (Human Body Model)	2000	V
–	ESD (Charged-device Model)	±1000	V

Note: 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
V_{CC}	Power Supply Voltage	7	25	V
T_A	Ambient Temperature	-40	+105	°C

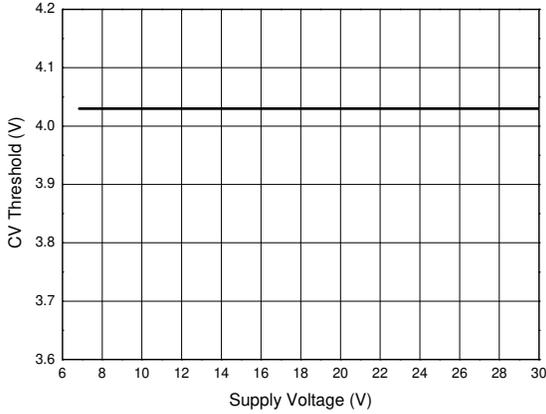
Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
UVLO Section						
V_{TH} (ST)	Start-up Threshold	–	13	14.5	16	V
V_{OPR} (Min)	Minimum Operating Voltage	After turn on	5.5	6.5	7.5	V
V_{CC_OVP}	VCC OVP Voltage	–	27	29	31	V
–	VCC Delatch Voltage (Note 5)	–	3	4	5	V
Standby Current Section						
I_{ST}	Start-up Current	$V_{CC} = V_{TH}$ (ST) -0.5V, Before start up	–	–	20	μA
I_{CC} (OPR)	Operating Current	Static	–	900	1300	μA
Drive Output Section						
I_{OUT}	Output Current (Note 5)	$V_{CS_PEAK} = 1V$	–	–	60	mA
V_{OS}	UVLO Saturation Voltage	$V_{CC} = 0$ to V_{CC-ON} , $I_{SINK} = 10mA$	–	–	1.1	V
Current Sense Section						
V_{CS_REF}	Current Sense Reference	–	–	1	–	V
V_{CS_CLAMP}	Current Sense Reference Clamp	–	1.2	1.4	–	V
t_{ONP_MIN}	Minimum t_{ONP}	–	700	–	1000	ns
$t_{D(H-L)}$	Delay to Output (Note 5)	–	50	150	250	ns
Feedback Input Section						
I_{FB}	Feedback Pin Input Leakage Current	$V_{FB} = 2V$	–	–	4	μA
V_{FB_CV}	FB CV Threshold	–	3.8	4	4.2	V
V_{FB_OVP}	FB OVP Threshold	–	4.5	6	7.5	V
Output Current						
–	System Output Current On Final Test Board	–	–	–	±2	%
Over Temperature Protection Section						
–	Shutdown Temperature (Note 5)	–	+150	–	–	°C
–	Temperature Hysteresis (Note 5)	–	–	+20	–	°C

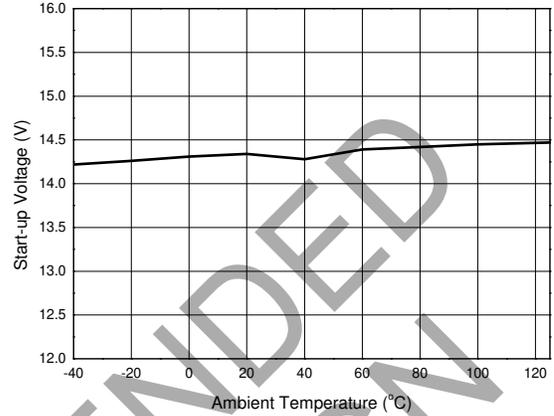
Note: 5. These parameters, although guaranteed by design, are not 100% tested in production.

Performance Characteristics

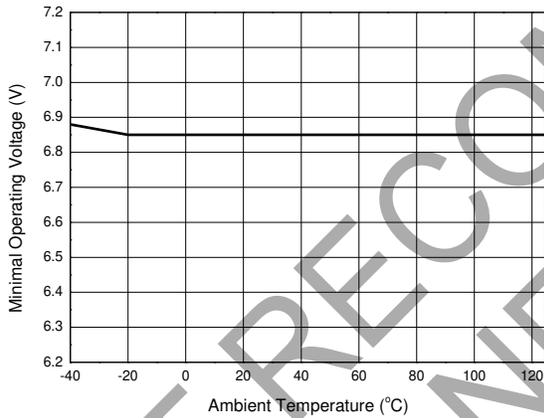
CV Threshold vs. Supply Voltage



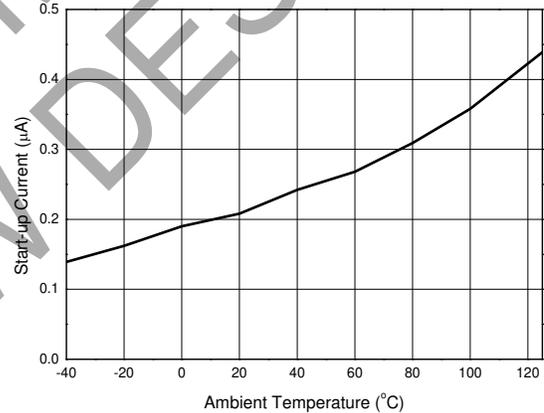
Start-up Voltage vs. Ambient Temperature



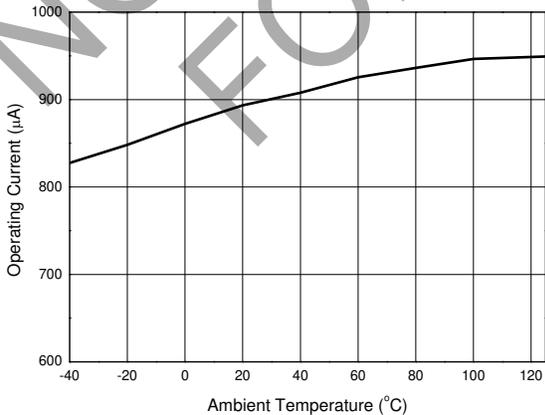
Minimal Operating Voltage vs. Ambient Temperature



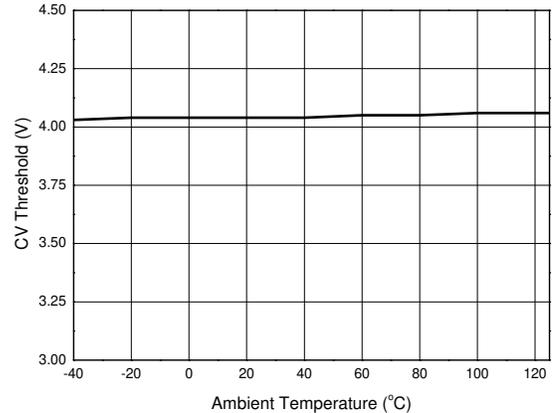
Start-up Current vs. Ambient Temperature



Operating Current vs. Ambient Temperature

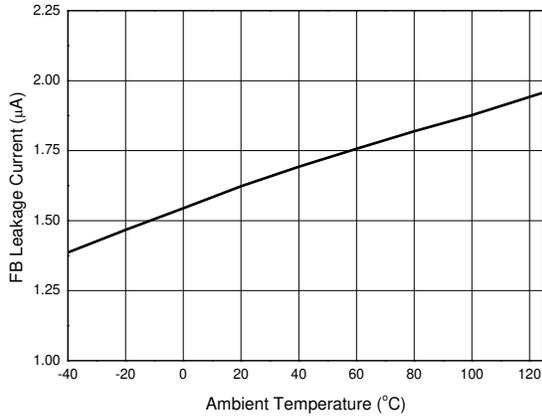


CV Threshold vs. Ambient Temperature

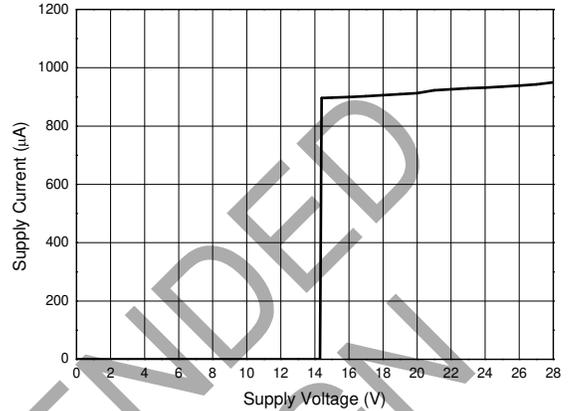


Performance Characteristics (Cont.)

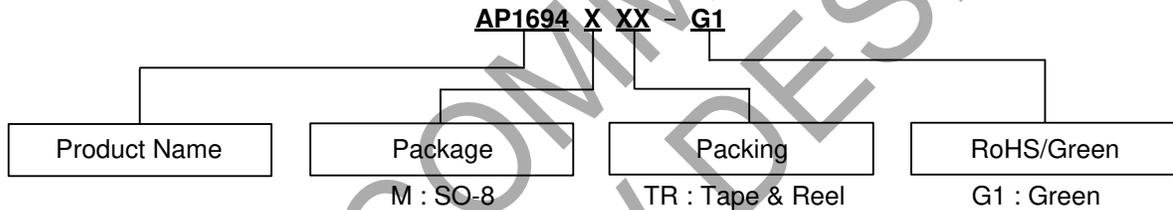
FB Leakage Current vs. Ambient Temperature



Supply Current vs. Supply Voltage

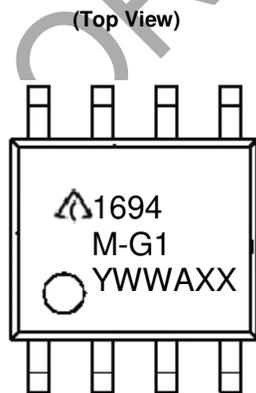


Ordering Information



Package	Ambient Temperature Range	Part Number	Marking ID	Packing
SO-8	-40°C to +105°C	AP1694MTR-G1	1694M-G1	4000/13" Tape & Reel

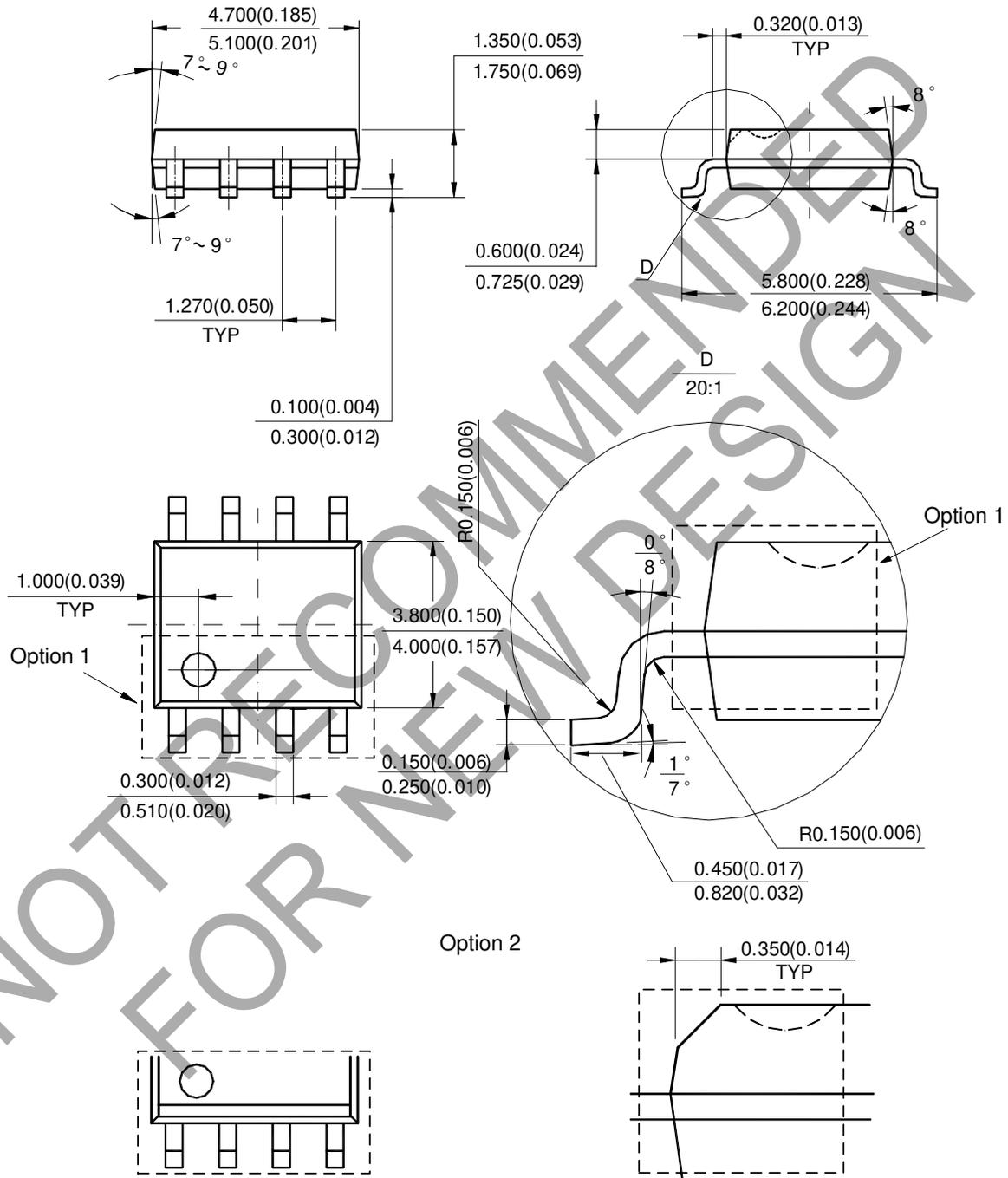
Marking Information



First and Second Lines: Logo and Marking ID
(See Ordering Information)
Third Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch No.

Package Outline Dimensions (All dimensions in mm (inch).)

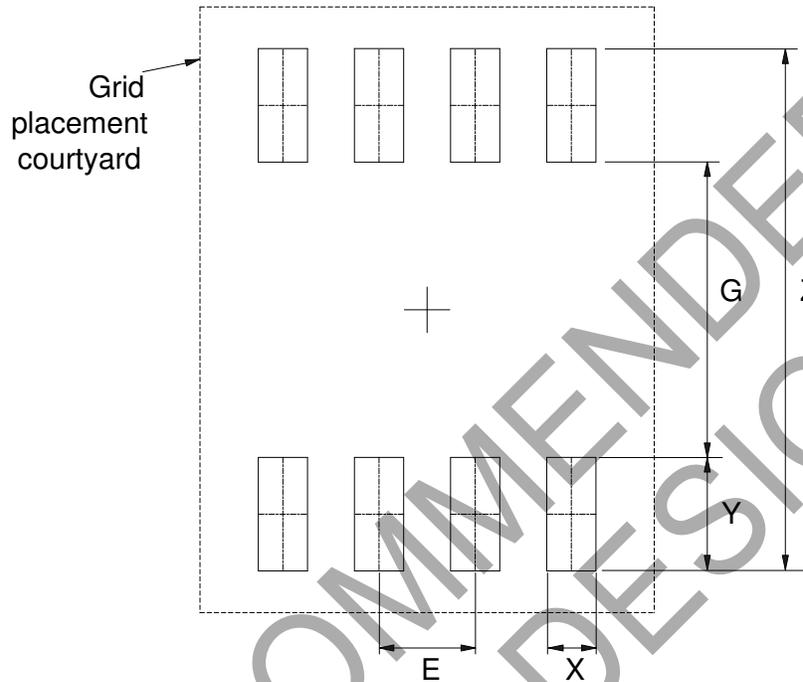
(1) Package Type: SO-8



Note: Eject hole, oriented hole and mold mark is optional.

Suggested Pad Layout

(1) Package Type: SO-8



Dimensions	Z (mm)/(inch)	G (mm)/(inch)	X (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050

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